

LOW DROPOUT VOLTAGE REGULATOR

■ GENERAL DESCRIPTION

NJM2874/75/76 is a low dropout voltage regulator designed for cellular phone application.

Advanced Bipolar technology achieves low noise, high ripple rejection and low quiescent current.

■ PACKAGE OUTLINE



NJM2874F/75F/76F

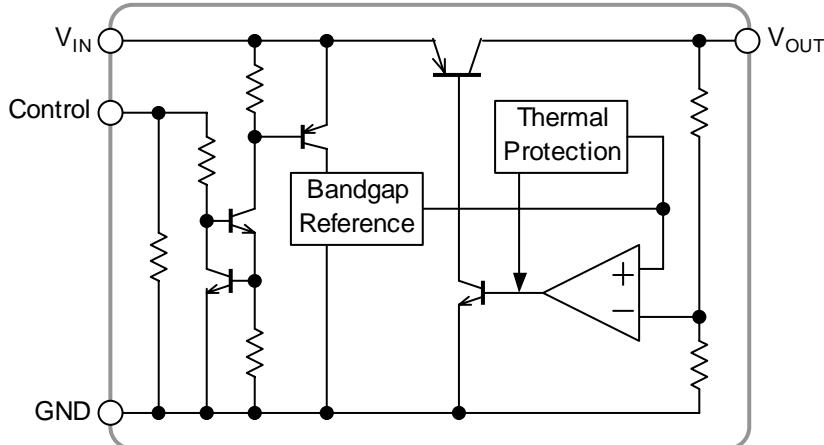
■ FEATURES

- High Ripple Rejection 75dB typ. ($f=1\text{kHz}$ $V_o=3\text{V}$ Version)
- Output Noise Voltage $V_{no}=45\mu\text{VRms}$ typ.
- Output capacitor with $1.0\mu\text{F}$ ceramic capacitor ($V_o \geq 2.7\text{V}$)
- Output Current $I_o(\text{max.})=150\text{mA}$
- High Precision Output $V_o \pm 1\%$
- Low Dropout Voltage 0.10V typ. ($I_o=60\text{mA}$)
- ON/OFF Control (Active High)
- Internal Short Circuit Current Limit
- Internal Thermal Overload Protection
- Bipolar Technology
- Package Outline SOT-23-5

■ PIN CONFIGURATION

		PIN FUNCTION		
		1.CONTROL	1. V_{IN}	1. V_{OUT}
		2.GND	2.GND	2.GND
		3.NC	3.CONTROL	3. V_{IN}
		4. V_{OUT}	4.NC	4.CONTROL
		5. V_{IN}	5. V_{OUT}	5.NC
NJM2874F		NJM2875F		NJM2876F

■ EQUIVALENT CIRCUIT



■ OUTPUT VOLTAGE RANK LIST

Device Name	V_{OUT}
NJM287xF21	2.1V
NJM287xF28	2.8V
NJM287xF03	3.0V
NJM287xF33	3.3V
NJM287xF05	5.0V

■ ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

PARAMETER	SYMBOL	RATINGS		UNIT
Input Voltage	V_{IN}	+14		V
Control Voltage	V_{CONT}	+14(*1)		V
Power Dissipation	P_D	SOT-23-5	350(*2) 200(*3)	mW
Operating Temperature	T_{OPR}	-40 ~ +85		°C
Storage Temperature	T_{STG}	-40 ~ +125		°C

(*1):When input voltage is less than +14V, the absolute maximum control voltage is equal to the input voltage.

(*2):Mounted on glass epoxy board. (114.3x76.2x1.6mm: 2Layer, FR-4)

(*3):Device itself

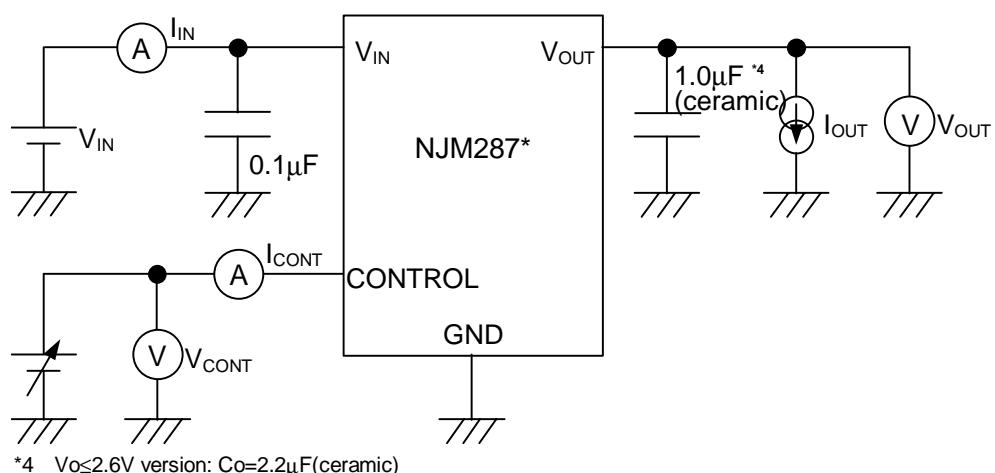
■ ELECTRICAL CHARACTERISTICS

(V_{IN}=V_O+1V, C_{IN}=0.1μF, C_O=1.0μF: V_O≥2.7V (C_O=2.2μF: V_O≤2.6V), Ta=25°C)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Voltage	V_O	$I_O=30mA$	-1.0%	-	+1.0%	V
Quiescent Current	I_Q	$I_O=0mA$, expect I_{CONT}	-	120	180	μA
Quiescent Current at Control OFF	$I_{Q(OFF)}$	$V_{CONT}=0V$	-	-	100	nA
Output Current	I_O	$V_O-0.3V$	150	200	-	mA
Line Regulation	$\Delta V_O / \Delta V_{IN}$	$V_{IN}=V_O+1V \sim V_O+6V$, $I_O=30mA$	-	-	0.10	%/V
Load Regulation	$\Delta V_O / \Delta I_O$	$I_O=0 \sim 100mA$	-	-	0.03	%/mA
Dropout Voltage	ΔV_{I-O}	$I_O=60mA$	-	0.10	0.18	V
Ripple Rejection	RR	$e_{IN}=200mVrms, f=1kHz$, $I_O=10mA$, $V_O=3V$ Version	-	75	-	dB
Average Temperature Coefficient of Output Voltage	$\Delta V_O / \Delta T_a$	$T_a=0 \sim 85^\circ C$, $I_O=10mA$	-	±50	-	ppm/°C
Output Noise Voltage	V_{NO}	$f=10Hz \sim 80kHz$, $I_O=10mA$, $V_O=3V$ Version	-	45	-	μVrms
Control Voltage for ON-state	$V_{CONT(ON)}$		1.6	-	-	V
Control Voltage for OFF-state	$V_{CONT(OFF)}$		-	-	0.6	V

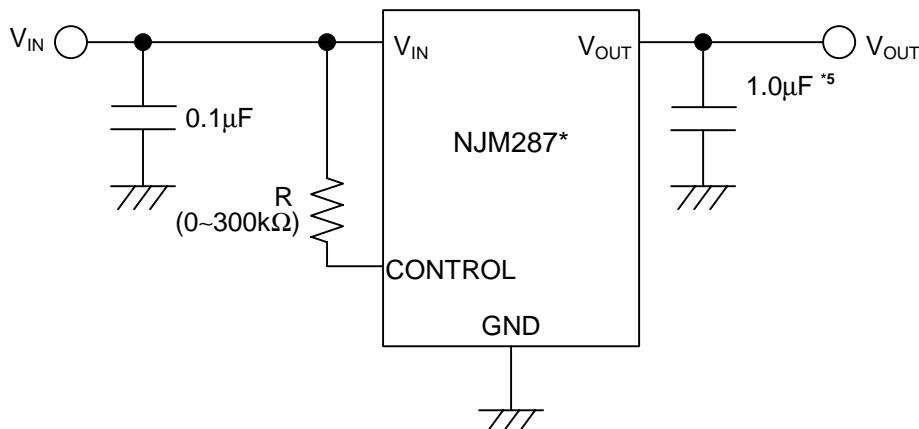
The above specification is a common specification for all output voltages.

Therefore, it may be different from the individual specification for a specific output voltage.

■ TEST CIRCUIT

■ TYPICAL APPLICATION

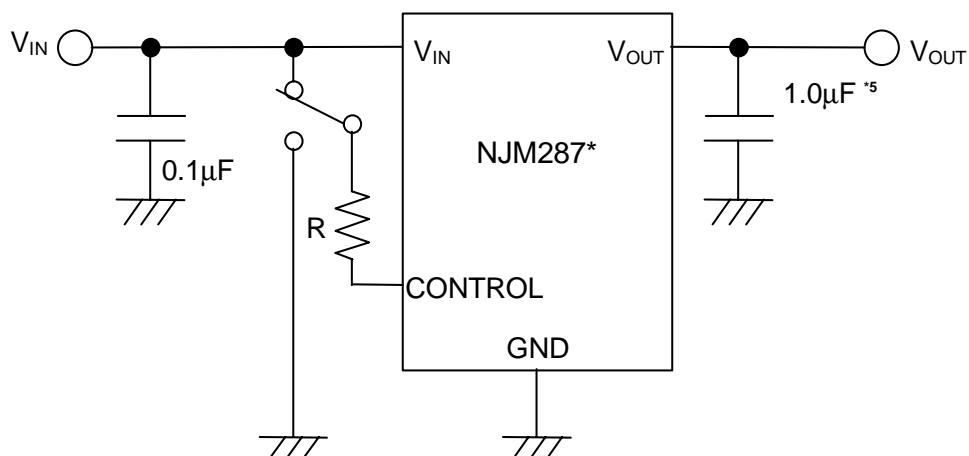
- ① In case that ON/OFF Control is not required:



*5 $V_{O \leq 2.6V}$ version: $C_O = 2.2\mu F$

Connect control terminal to V_{IN} terminal

- ② In use of ON/OFF CONTROL:



*5 $V_{O \leq 2.6V}$ version: $C_O = 2.2\mu F$

State of control terminal:

- “H” → output is enabled.
- “L” or “open” → output is disabled.

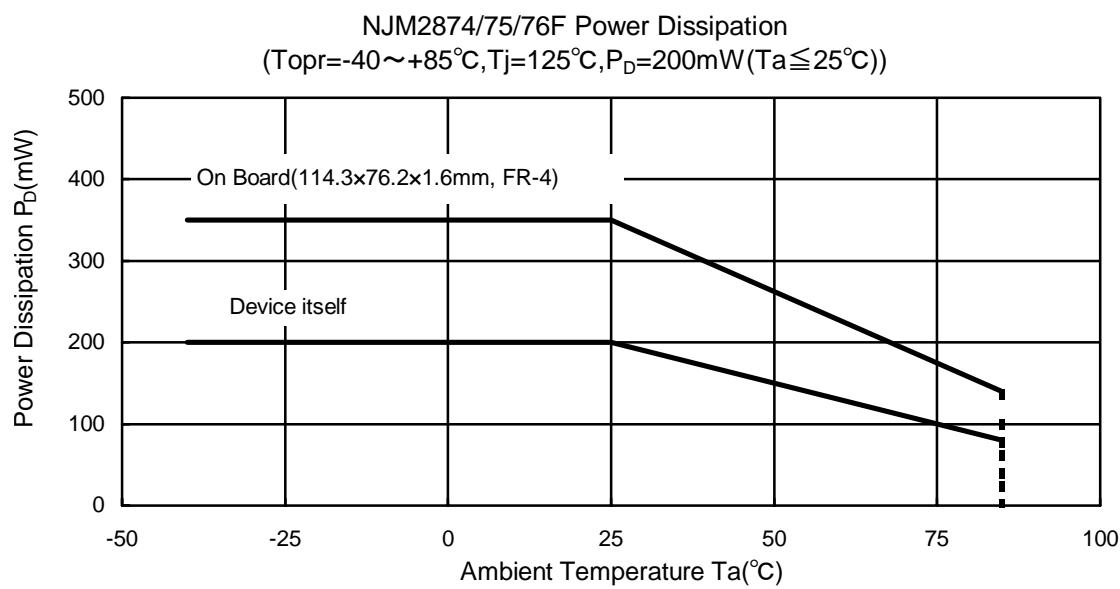
*Noise bypass Capacitance C_p

Noise bypass capacitance C_p reduces noise generated by band-gap reference circuit. Noise level and ripple rejection will be improved when larger C_p is used. Use of smaller C_p value may cause oscillation. Use the C_p value of $0.01\mu F$ greater to avoid the problem.

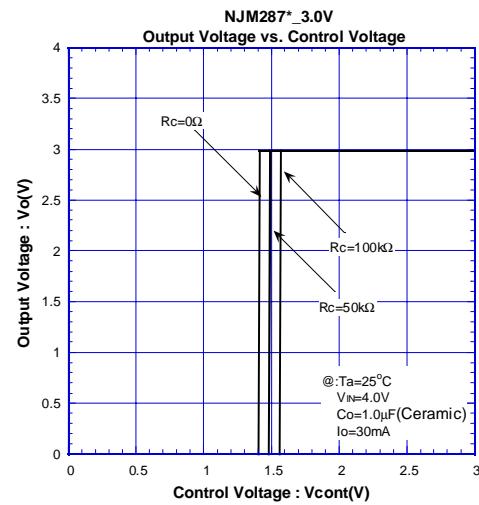
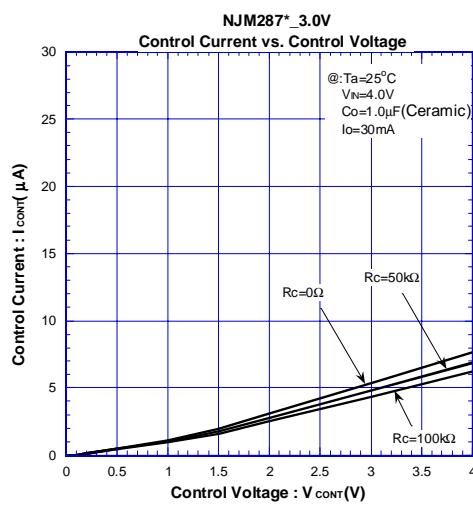
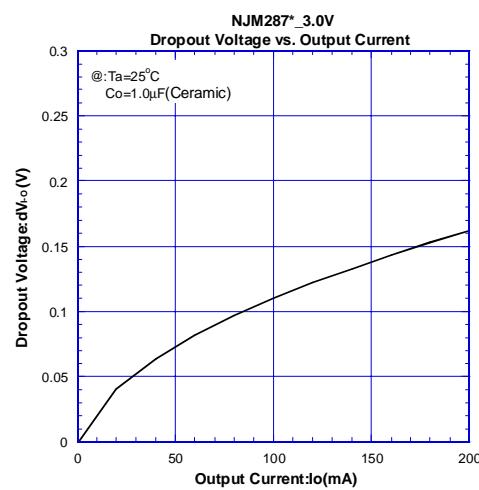
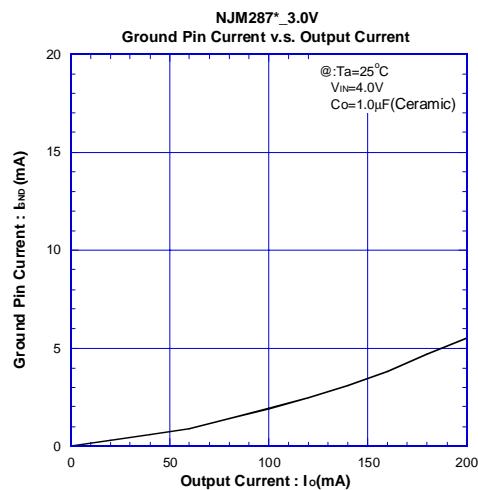
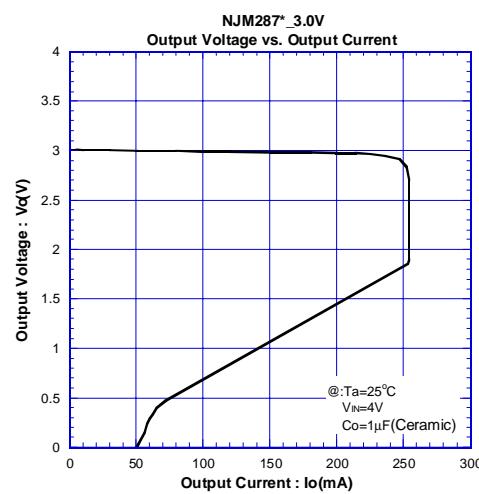
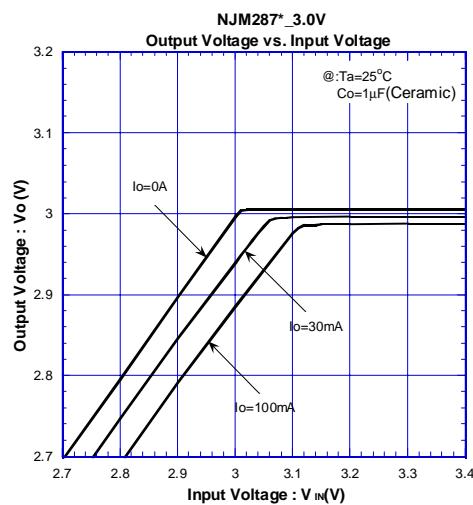
*In the case of using a resistance "R" between V_{IN} and control.

The current flow into the control terminal while the IC is ON state (I_{CONT}) can be reduced when a pull up resistance "R" is inserted between V_{IN} and the control terminal.

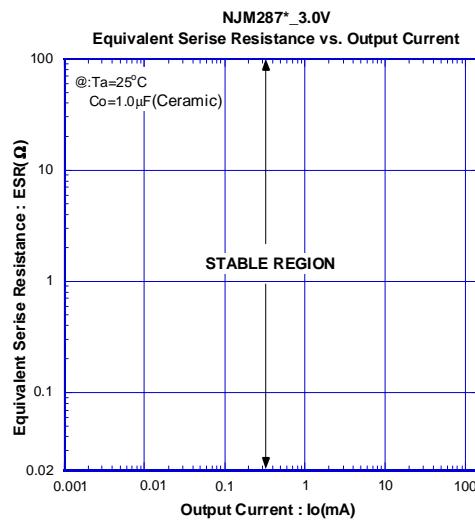
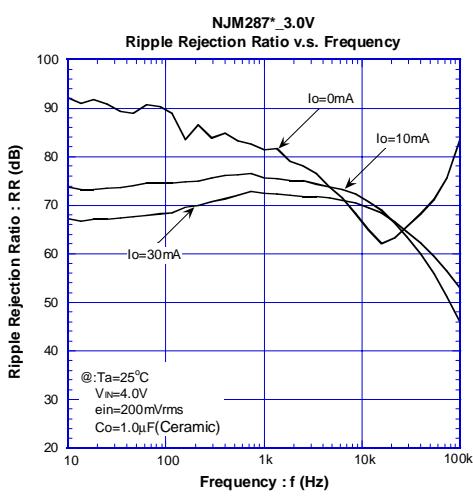
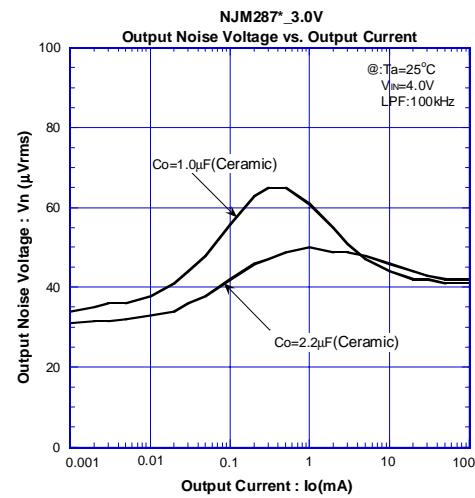
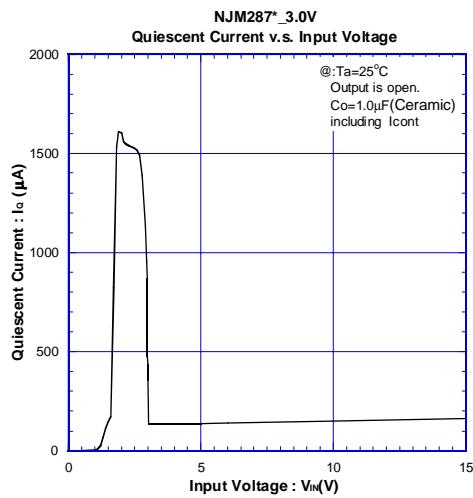
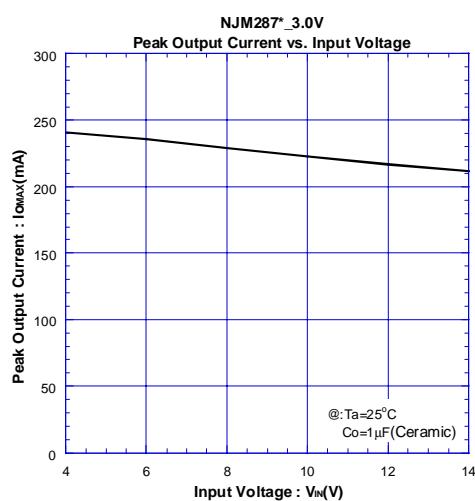
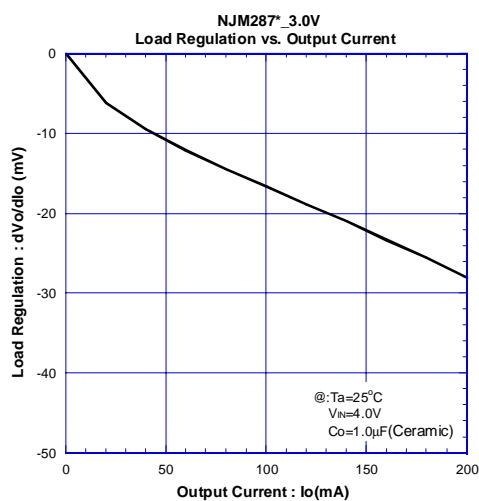
The minimum control voltage for ON state ($V_{CONT(ON)}$) is increased due to the voltage drop caused by I_{CONT} and the resistance "R". The I_{CONT} is temperature dependence as shown in the "Control Current vs. Temperature" characteristics. Therefore, the resistance "R" should be carefully selected to ensure the control voltage exceeds the $V_{CONT(ON)}$ over the required temperature range.

■ POWER DISSIPATION vs. AMBIENT TEMPERATURE

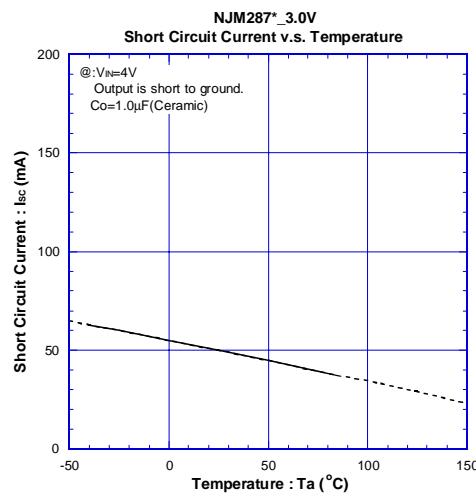
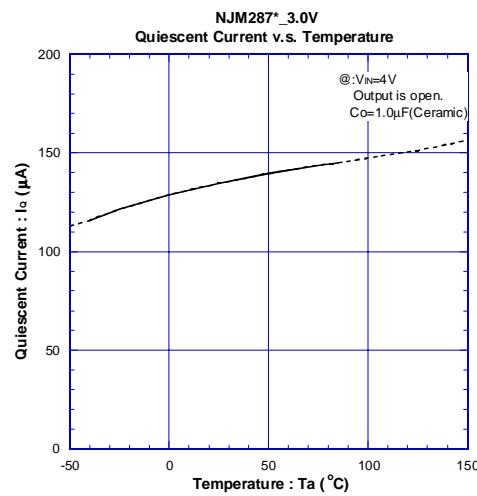
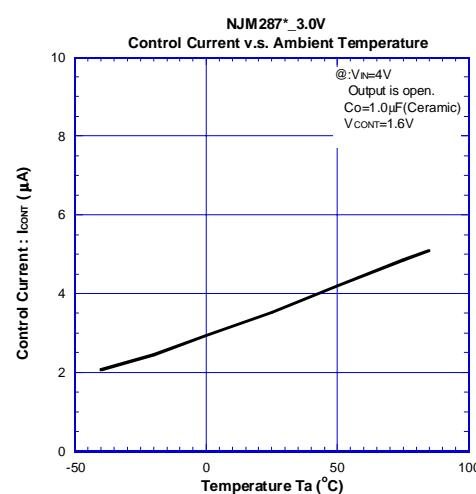
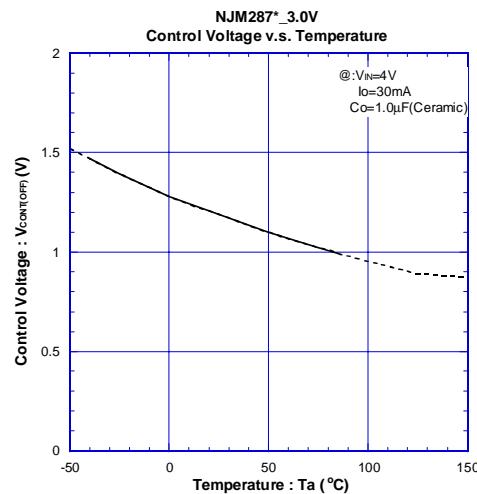
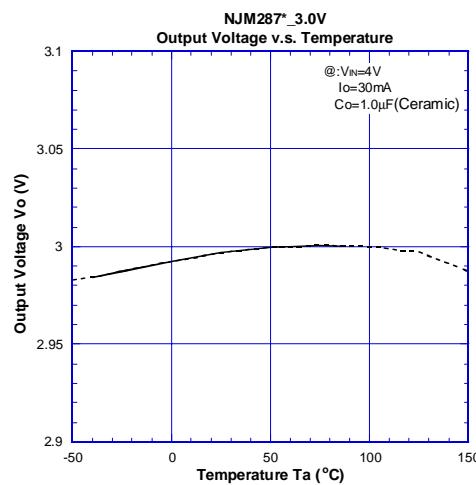
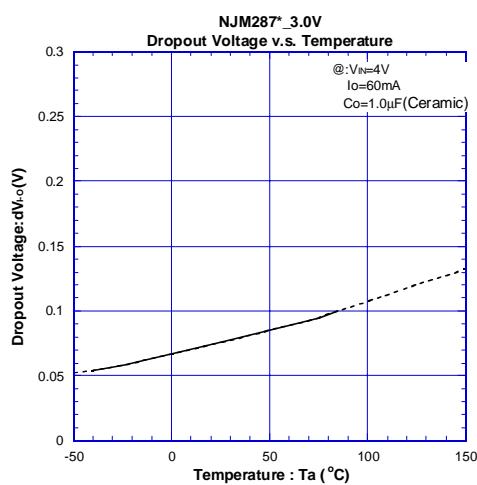
■ ELECTRICAL CHARACTERISTICS

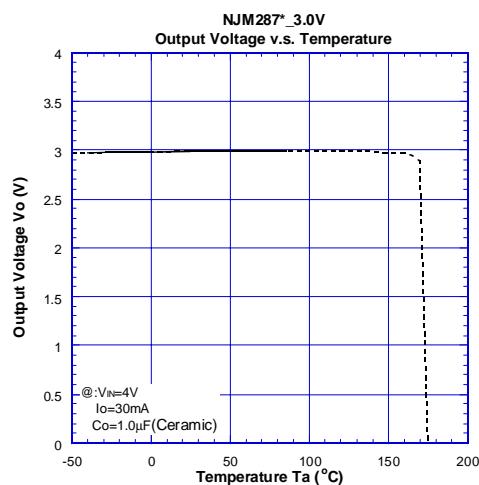
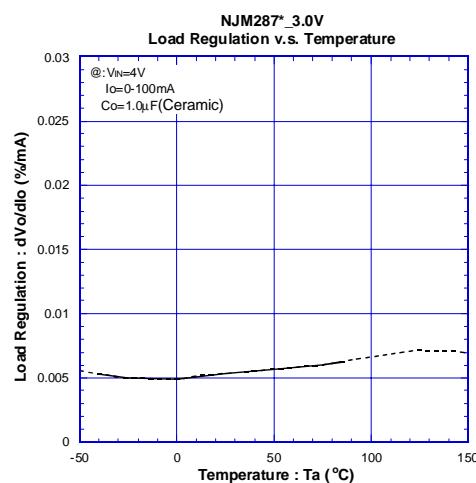
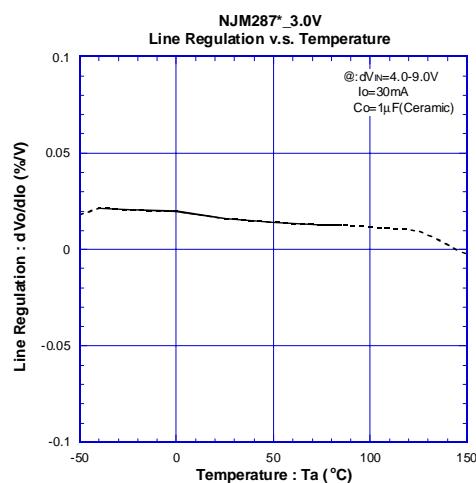


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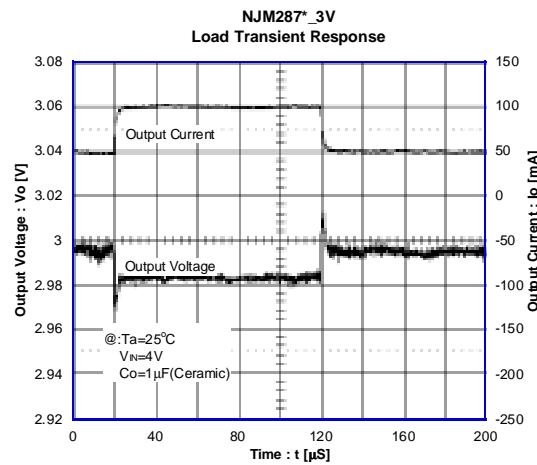
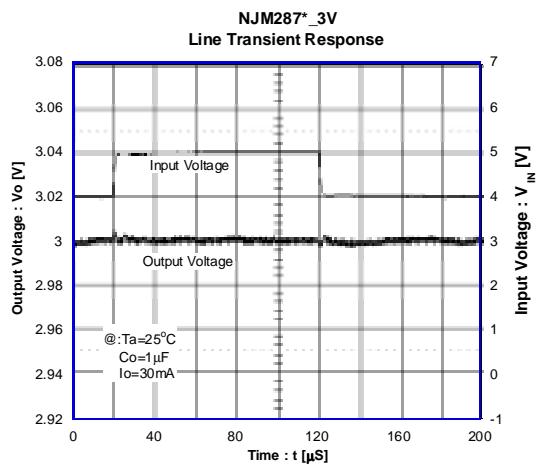
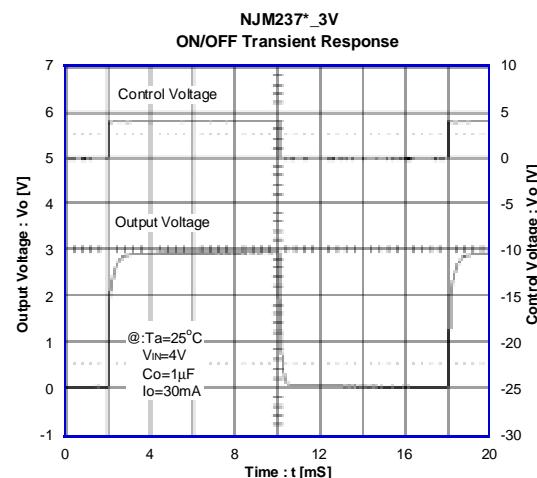
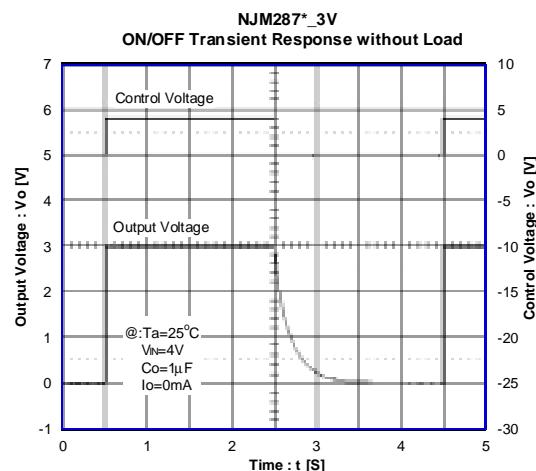


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